



DMT64M2LPSW

60V N-CHANNEL ENHANCEMENT MODE MOSFET PowerDI5060-8

Product Summary

BV _{DSS}	Rds(on) Max	Ι _D T _C = +25°C
60V	4.4mΩ @ V _{GS} = 10V	100A
	6.4mΩ @ V _{GS} = 4.5V	85A

Description and Applications

This MOSFET is designed to minimize the on-state resistance (RDS(ON)) yet maintain superior switching performance, making it ideal for high-efficiency power management applications.

- High Frequency Switching
- Synchronous Rectification
- **DC-DC Converters**

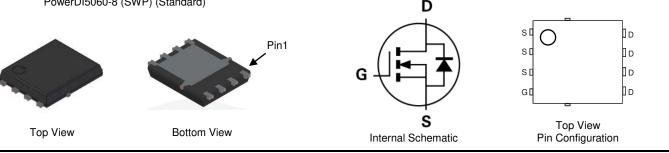
PowerDI5060-8 (SWP) (Standard)

Features

- 100% Unclamped Inductive Switching (UIS) Test in Production -Ensures More Reliable and Robust End Application
- High Conversion Efficiency
- Low RDS(ON) Minimizes Power Losses
- Low Q_G Minimizes Switching Losses
- Wettable Flank for Improved Optical Inspection
- Fast Switching Speed
- Low Input Capacitance
- Lead-Free Finish; RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- For automotive applications requiring specific change control (i.e. parts gualified to AEC-Q100/101/200, PPAP capable, and manufactured in IATF 16949 certified facilities), please contact us or your local Diodes representative. https://www.diodes.com/quality/product-definitions/

Mechanical Data

- Case: PowerDI[®]5060-8
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Finish Matte Tin Annealed over Copper Leadframe. Solderable per MIL-STD-202, Method 208 (e3)
- Weight: 0.097 grams (Approximate)



Ordering Information (Note 4)

Part Number	6260	Packaging
DMT64M2LPSW-13	PowerDI5060-8 (SWP) (Standard)	2500/Tape & Beel
DIVI1641VI2LP5VV-13	PowerDI5060-8 (SWP) (Standard)	2500/Tape & Reel

Notes: 1. EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant. All applicable RoHS exemptions applied. 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.

3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

Marking Information



 $\mathcal{D}_{\mathcal{A}}^{\mathcal{A}} = \mathsf{Manufacturer's} \mathsf{Marking}$ T64M2LSW = Product Type Marking Code YYWW or YYWW= Date Code Marking YY or \overline{YY} = Year (ex: 20 = 2020) WW = Week (01 to 53)

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Maximum Ratings (@TA = +25°C, unless otherwise specified.)

Characte	Symbol	Value	Unit		
Drain-Source Voltage			VDSS	60	V
Gate-Source Voltage			V _{GSS}	±20	V
Continuous Drain Current (Note 5)	Steady State	TA = +25°C TA = +70°C	ID	20.7 16.6	А
Continuous Drain Current (Note 6) $T_{C} = +25^{\circ}C$ $T_{C} = +70^{\circ}C$			ID	100 82	А
Maximum Continuous Body Diode Forward Current (Note 6)			ls	100	А
Pulsed Drain Current (10µs Pulse, Duty Cycle = 1%)			Ідм	400	А
Pulsed Body Diode Forward Current (10µs Pulse, Duty Cycle = 1%)			lsм	400	А
Avalanche Current, L = 1mH			las	18.2	А
Avalanche Energy, L = 1mH			Eas	165.6	mJ

Thermal Characteristics

Characteristic		Symbol	Value	Unit
Total Power Dissipation (Note 5)	T _A = +25°C	PD	2.8	W
Thermal Resistance, Junction to Ambient (Note 5)	Steady State	R _{ÐJA}	44	°C/W
Total Power Dissipation (Note 6)	Tc = +25°C	PD	83.3	W
Thermal Resistance, Junction to Case (Note 6)		R _{ejc}	1.5	°C/W
Operating and Storage Temperature Range		TJ, TSTG	-55 to +150	°C

Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 7)	- ,		- 71-				
Drain-Source Breakdown Voltage	BV _{DSS}	60	—		V	$V_{GS} = 0V, I_D = 1mA$	
Zero Gate Voltage Drain Current	IDSS		—	1	μA	$V_{DS} = 48V, V_{GS} = 0V$	
Gate-Source Leakage	lgss	_	—	±100	nA	$V_{GS} = \pm 20V, V_{DS} = 0V$	
ON CHARACTERISTICS (Note 7)							
Gate Threshold Voltage	VGS(TH)	1.2	-	2.5	V	$V_{DS} = V_{GS}$, $I_D = 250 \mu A$	
Static Drain-Source On-Besistance	Descent	—	3.3	4.4	mΩ	$V_{GS} = 10V, I_D = 50A$	
Static Drain-Source On-Resistance	RDS(ON)	—	4.7	6.4	11122	V _{GS} = 4.5V, I _D = 12.5A	
Diode Forward Voltage	V _{SD}	_	0.8	1.2	V	V _{GS} = 0V, I _S = 50A	
DYNAMIC CHARACTERISTICS (Note 8)							
Input Capacitance	Ciss	_	2799	_		V _{DS} = 30V, V _{GS} = 0V, f = 1MHz	
Output Capacitance	Coss	—	950	—	pF		
Reverse Transfer Capacitance	Crss	—	79	—			
Gate Resistance	Rg	—	0.63	—	Ω	$V_{DS} = 0V$, $V_{GS} = 0V$, $f = 1MHz$	
Total Gate Charge (V _{GS} = 10V)	Q _G	—	46.7	—			
Total Gate Charge (V _{GS} = 4.5V)	QG	—	24.1	—	nC	$V_{DD}=30V,\ I_D=50A$	
Gate-Source Charge	Qgs	_	8.2	_	no		
Gate-Drain Charge	Qgd	_	11.0	_			
Turn-On Delay Time	t _{D(ON)}	_	6.5	_		$V_{DD} = 30V, V_{GS} = 10V,$ $I_D = 30A, R_G = 3.3\Omega$	
Turn-On Rise Time	t _R	_	6.9	_			
Turn-Off Delay Time	tD(OFF)		26.1		ns		
Turn-Off Fall Time	tF		11.2				
Body Diode Reverse Recovery Time	trr		40.1	—	ns		
Body Diode Reverse Recovery Charge	Qrr	_	51.1	—	nC	IF = 30A, di/dt = 100A/μs	

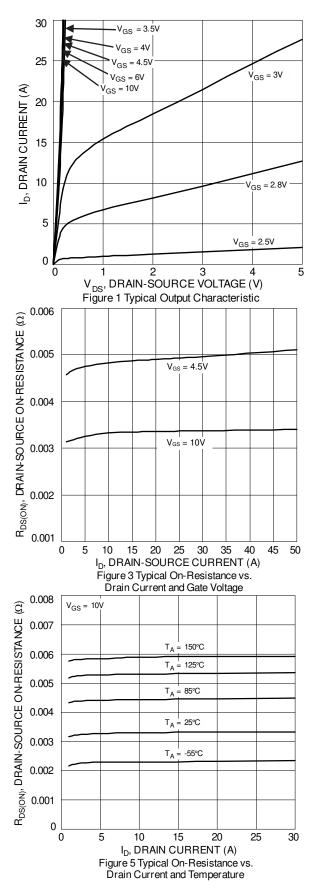
 Device mounted on FR-4 substrate PC board, 2oz copper, with thermal bias to bottom layer 1inch square copper plate.
Thermal resistance from junction to soldering point (on the exposed drain pad). Notes:

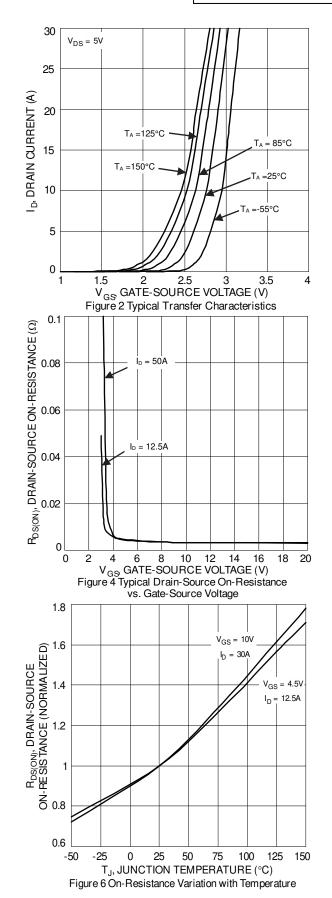
7. Short duration pulse test used to minimize self-heating effect.

8. Guaranteed by design. Not subject to product testing.

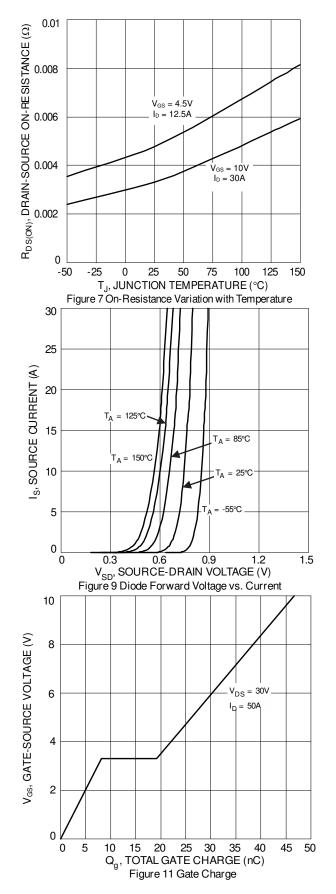


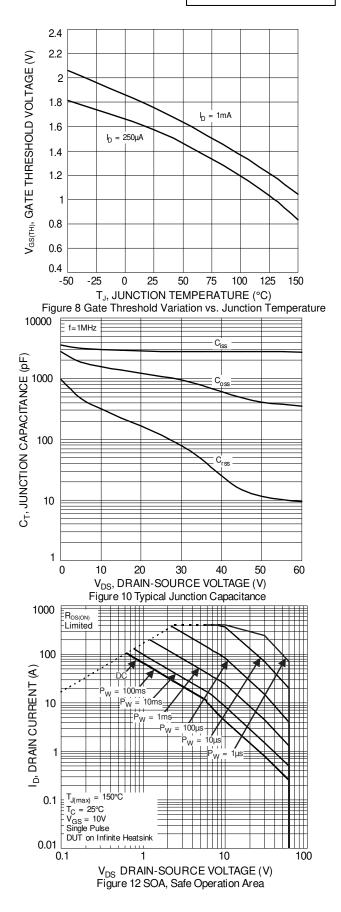




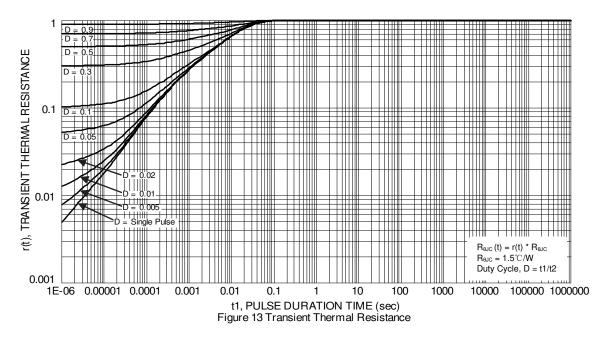








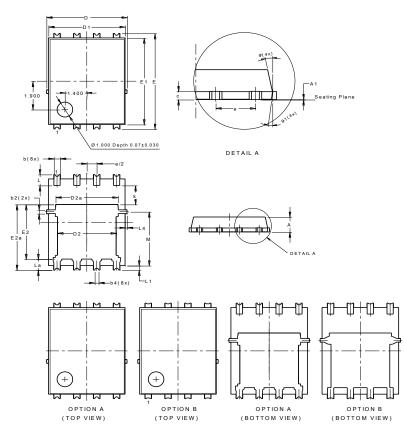






Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.



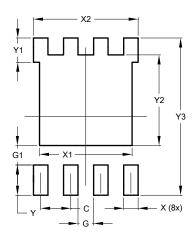
PowerDI5060-8 (SWP) (Standard)

Pov	PowerDI5060-8 (SWP) (Standard)					
Dim	Min	Min Max				
Α	0.90	1.10	1.00			
A1	0	0.05				
b	0.30	0.50	0.41			
b2	0.20	0.35	0.25			
b4	().25REF	-			
С	0.230	0.330	0.277			
D	5.15 BSC					
D1	4.70	5.10	4.90			
D2	3.56	3.96	3.76			
D2a	3.78	4.18	3.98			
E	6	.40 BS0	0			
E1	5.60	6.00	5.80			
E2	3.46	3.86	3.66			
E2a	4.195	4.595	4.395			
е	1	.27BSC)			
k	1.05					
L	0.635	0.835	0.735			
La	0.635	0.835	0.735			
L1	0.200	0.400	0.300			
L4	0.025	0.225	0.125			
М	3.205	4.005	3.605			
θ	10°	12°	11°			
θ1	6°	8°	7°			
All	All Dimensions in mm					

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

PowerDI5060-8 (SWP) (Standard)



Dimensions	Value (in mm)		
С	1.270		
G	0.660		
G1	0.820		
Х	0.610		
X1	4.100		
X2	4.420		
Y	1.270		
Y1	1.020		
Y2	3.810		
Y3	6.610		



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